Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S12	6	US-5856230-\$.DID. OR US-5893760-\$. DID. OR US-6303471-\$.DID. OR US-6579748-\$.DID. OR US-6603191-\$. DID. OR US-6656820-\$.DID.	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:15
S13	1	US-20030017652-\$.DID.	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/02/28 10:34
S14	2	jp-11035784-\$.did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2006/05/16 07:41
S15	0	11-035784	JPO; DERWENT	ADJ	ON	2006/05/16 07:42
S16	2	"11035784"	JPO; DERWENT	ADJ	ON	2006/05/16 07:44
S17	0	"035784"	JPO; DERWENT	ADJ	ON	2006/05/16 07:42
S18	0	"035784"	JPO; DERWENT	ADJ	ON	2006/05/16 07:42
S19	2	11-035784	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2006/05/16 07:42
S20	0	"11035784"	US-PGPUB; USPAT; EPO	ADJ	ON	2006/05/16 07:44
S21	2145	stress near2 (balance or balancing)	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/17 14:06
S22	19	(semiconductor substrate) same S21	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/17 15:10
S23	5085	(semiconductor substrate) same stress	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:17
S24	27	S21 same passivation	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/17 15:12

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S25	25	S24 not S22	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/17 15:12
S26	21	S25 and (@ad<"20020225" or @ad<"20020225")	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:28
S27	8459	(physical vapor) with sputtering	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:16
S28	8284	(physical vapor deposition) with sputtering	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:16
S29	5434	(physical vapor deposition) near3 sputtering	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:17
S30	5094	(semiconductor substrate) same stress	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:17
S31	123	S27 and S30	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:18
S32	2147	stress near2 (balance or balancing)	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:18
S33	22	S27 and S32	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:25
S34	92	(transimpedance amplifier) and passivation	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:27
S35	0	(transimpedance amplifier) same passivation	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 09:27
S36	35	S34 and (@ad<"20020225" or @ad<"20020225")	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 08:43

S37	1	"5300172".pn.	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 10:50
S38	44	S32 same adhesive	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/19 10:50
S39	28	S38 and (@ad<"20020225" or @ad<"20020225")	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 08:41
S40	9176	substrate same back same adhesive	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 08:42
S41	3837	substrate with back with adhesive	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 08:43
S42	713	substrate near3 back near3 adhesive	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 08:43
S43	267	substrate near2 back near2 adhesive	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 08:43
S44	195	S43 and (@ad<"20020225" or @ad<"20020225")	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 08:46
S45	69	S42 same semiconductor	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 08:45
S46	38	S45 and (@ad<"20020225" or @ad<"20020225")	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 09:40

S48	179	("0596062" "200100169	"20010004   2001"   "2001	313"   0024820"	US-PGPUB; USPAT;	ADJ	ON	2006/05/22 09:1
		"20010044155"   "20010045270"   "20010046703"   "20010055714"			USOCR			
		"200200113	•	0075645"				
		"200201211	•	0121274"				
		"20040040695"   "20040089008"						
		"20040125	561"   "20040	0207986"				
		"2273505"	"3654988"	"3817321"				
		"3823572"	3929154"	"3946276"				
		"4109707"	"4138996"	"4194559"				
		"4203448"	"4211208"	"4235285"				
		"4248295"	"4312012"	"4345267"				
		"4450472"	"4485429"	"4516632"				
		"4561040"	"4567505"	"4573067"				
		"4664181"	"4716494"	"4758926"				
		"4866570"	"4868712"	"4894709"				
		"4896719"	"4908112"	"4938280"				
		"4978638"	"5009760"	"5016138"				
		"5057908"	"5058627"	"5070040"				
		"5083194"	"5088005"	"5099311"				
		"5099910"	"5125451"	"5131233"				
		"5203401"	"5218515"	"5232047"				
		"5239200"	"5263251"	"5274920"				
		"5309319"	"5317805"	"5325265"				
		"5380956" "E427174"	"5383340"	"5397919"				
		"5427174" "EE09224"	"5436793"   "EE14933"	"5459099"				
		"5508234" "5544696"	"5514832"   "5548605"	"5514906"				
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		"5646824"	"5692558"	"5696405"				
		"5703536"	"5704416"	"5727618"				
		"5731954"	"5763951"	"5774779"				
		"5800690"	"5801442"	"5835345"				
		"5836750"	"5858188"	"5863708"				
		"5869004"	"5870823"	"5874795"				
		"5876655"	"5880017"	"5880524"				
		"5886870"	"5901037"	"5936192"				
		"5940270"	"5942093"	"5964092"				
		"5965001"	"5965813"	"5978220"				
		"5997713"	"5998240"	"6007309"				
		"6010316"	"6013164"	"6014312"				
		"6019882"	("6021045")	.PN. OR				
		("6054034"	"6068752"	"6090251"				
		"6096656"	"6100541"	"6101715"				
		"6119729"	"6126723"	"6129145"				
		"6131650"	"6146103"	"6154363"				
		"6159353"	"6166907"	"6174675"				
		"6176962"	"6186660"	"6210986"				
		"6216343"	"6221226"	"6227809"				
		"6234240"	"6238538"	"6277257"				
		"6301109"	"6313992"	"6317326"				
		"6321791"	"6322753"	"6324058"				
		"6337794"	"6347036"	"6351384"				
		"6381813"	"6388317"	"6397932"				
23/06 8:18:	21 AM	— <del>"6400012"</del> -"6417060" tipgs\ayylsop\ 6444461	- <mark>"6406605"</mark>   ."6424531"	<del>"6415860"  </del>  ." <u>644</u> 3222"				Pag

cuments and Settings(БуўјБўр/Муў Dōcümēnts\FAST) workspaces\10\107\10706212.wsp 6444461 | 6449157 | 6449162 | "6457515" | "6450582" | "6465015" |

S49	56	S48 and adhesive	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 09:39
S50	67	S40 same marking	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 09:39
S51	10	S40 same (laser marking)	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 09:39
S52	36	S50 and (@ad<"20020225" or @ad<"20020225")	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	ADJ	ON	2006/05/22 09:40